

PATENT ASSIGNMENT

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NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
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Tae-sung Park	02/22/2011
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13072746
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ASSIGNMENT

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Gyeonggi-do, Republic of Korea

Title of Invention: SEMICONDUCTOR PACKAGE SUBSTRATE AND
SEMICONDUCTOR PACKAGE HAVING THE SAME

U.S. Patent Application:

Application Serial No.:

Filing Date:

U.S. Patent No.:

Issued:

For good and valuable consideration, the receipt of which is hereby acknowledged, the above-named Assignor hereby sells, assigns and transfers to Assignee, the full and exclusive right, title and interest in and to the above-identified invention, patent application and patent rights throughout the world, including foreign patent priority rights; said invention, application and letters patent in this or any foreign country, and all divisions, continuations, reissues, non-provisionals and extensions thereof, to be held and enjoyed by Assignee, for its

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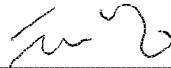
In the event that the patent application filing date or serial number is not known at the time this document is executed, Assignor hereby grants permission to the attorneys of record in the patent application to fill in the filing date and/or serial number above, and to record this assignment after such information is added.

Executed at Hwa Sung, Korea, this 22 day of
(city) (country)
February, 2011.



Won-gi Chang
Assignor

Executed at Hwa Sung, Korea, this 22 day of
(city) (country)
Feb., 2011.



Tae-sung Park
Assignor